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U.S.	UTIL	ITY	Patent	Ap	plication

TO O.I.P.E.	PATENT DATE
SCANNED ACT Q.A. A.C.	

.	APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER //
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Wilfried Abmor Rodiger Schmolk Erich Daub Christoph Frey

TITLE

Semiconductor wafer made from military and mathod for producing the semiconductor wafer

ISSUING CLASSIFICATION

ORIGINAL CROSS REFERENCE(S)

CLASS SUBCLASS CLASS SUBCLASS (ONE SUBCLASS PER BLOCK)

INTERNATIONAL CLASSIFICATION

Continued on Issue Slip Inside File Jacket

TERMINAL	DRAWINGS			CLAIMS ALLOWED	
L DISCLAIMER	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
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The term of this patent subsequent to (date)	i			NOTICE OF ALI	LOWANCE MAILED
has been disclaimed.	(Assistant i	Examiner)	(Date)		
The term of this patent shall not extend beyond the expiration date					
of U.S Patent. No.				ISS	UE FEE
				Amount Due	Date Paid
	(Primary E	xaminer)	(Date)		
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this patent have been disclaimed.	(Legal Instrume	ints Examiner)	(Date)		
WARNING:					
The Information disclosed herein may be res Possession outside the U.S. Patent & Traden					5, Sections 122, 181 and 368
orm <b>PTO-436A</b> Rev. 6/99)			FILED WITH:	DISK (CRF)	FICHE CD-RO
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